

# EVVOSEMI<sup>®</sup>

THINK CHANGE DO



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

## Product Specification

▶ Domestic	Part Number	IRLZ44NS
▶ Overseas	Part Number	IRLZ44NS
▶ Equivalent	Part Number	IRLZ44NS

EV is the abbreviation of name EVVO

## 60V N-Channel Enhancement Mode MOSFET

### Description

The IRLZ44NS uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

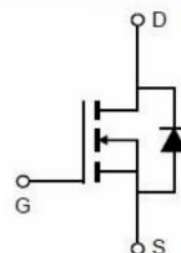
### Application

Battery protection  
 Load switch  
 Uninterruptible power supply

### General Features

$V_{DS} = 60V$   $I_D = 50A$   
 $R_{DS(ON)} < 12m\Omega$  @  $V_{GS} = 10V$   
 $R_{DS(ON)} < 15m\Omega$  @  $V_{GS} = 4.5V$

### TO-263 Pin Configuration



### Absolute Maximum Ratings ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D @ T_C = 25^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10V^1$	50	A
$I_D @ T_C = 100^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10V^1$	25	A
$I_D @ T_A = 25^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10V^1$	7.4	A
$I_D @ T_A = 70^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10V^1$	6	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	90	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	39.2	mJ
$I_{AS}$	Avalanche Current	28	A
$P_D @ T_C = 25^\circ\text{C}$	Total Power Dissipation <sup>4</sup>	45	W
$P_D @ T_A = 25^\circ\text{C}$	Total Power Dissipation <sup>4</sup>	2	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>	62	$^\circ\text{C/W}$

**60V N-Channel Enhancement Mode MOSFET**

$R_{\theta JC}$	Thermal Resistance Junction-Case <sup>1</sup>	2.8	°C/W
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**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

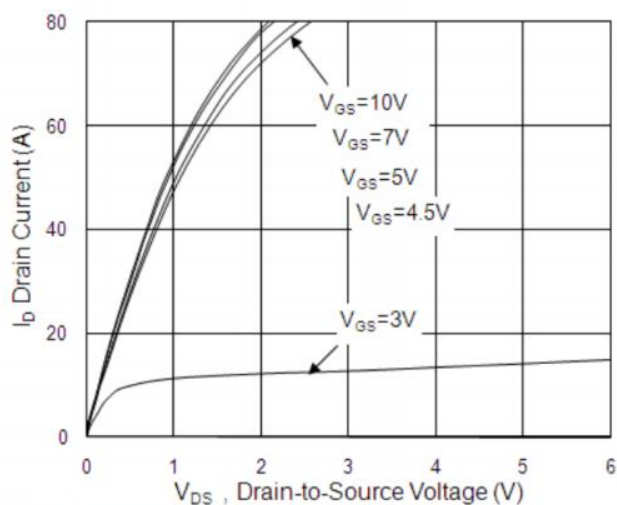
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V$ , $I_D=250\mu A$	60	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	$BV_{DSS}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_D=1\text{mA}$	---	0.057	---	V/ $^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=10V$ , $I_D=20A$	---	10	13	m $\Omega$
		$V_{GS}=4.5V$ , $I_D=10A$	---	12	15	
$V_{GS(th)}$	Gate Threshold Voltage		1.2	---	2.5	V
$\Delta V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=250\mu A$	---	-5.68	---	mV/ $^\circ\text{C}$
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=48V$ , $V_{GS}=0V$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu A$
		$V_{DS}=48V$ , $V_{GS}=0V$ , $T_J=55^\circ\text{C}$	---	---	5	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$	---	---	$\pm 100$	nA
$g_{fs}$	Forward Transconductance	$V_{DS}=5V$ , $I_D=15A$	---	45	---	S
$R_g$	Gate Resistance	$V_{DS}=0V$ , $V_{GS}=0V$ , $f=1\text{MHz}$	---	1.7	---	$\Omega$
$Q_g$	Total Gate Charge (4.5V)	$V_{DS}=48V$ , $V_{GS}=4.5V$ , $I_D=15A$	---	19.3	---	nC
$Q_{gs}$	Gate-Source Charge		---	7.1	---	
$Q_{gd}$	Gate-Drain Charge		---	7.6	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=30V$ , $V_{GS}=10V$ , $R_G=3.3\Omega$ , $I_D=15A$	---	7.2	---	ns
$T_r$	Rise Time		---	50	---	
$T_{d(off)}$	Turn-Off Delay Time		---	36.4	---	
$T_f$	Fall Time		---	7.6	---	
$C_{iss}$	Input Capacitance	$V_{DS}=15V$ , $V_{GS}=0V$ , $f=1\text{MHz}$	---	2423	---	pF
$C_{oss}$	Output Capacitance		---	145	---	
$C_{rss}$	Reverse Transfer Capacitance		---	97	---	
$I_S$	Continuous Source Current <sup>1,5</sup>	$V_G=V_D=0V$ , Force Current	---	---	35	A
$I_{SM}$	Pulsed Source Current <sup>2,5</sup>		---	---	80	A
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	$V_{GS}=0V$ , $I_S=A$ , $T_J=25^\circ\text{C}$	---	---	1	V
$t_{rr}$	Reverse Recovery Time	$I_F=15A$ , $di/dt=100A/\mu s$ , $T_J=25^\circ\text{C}$	---	16.3	---	nS
$Q_{rr}$	Reverse Recovery Charge		---	11	---	nC

Note :

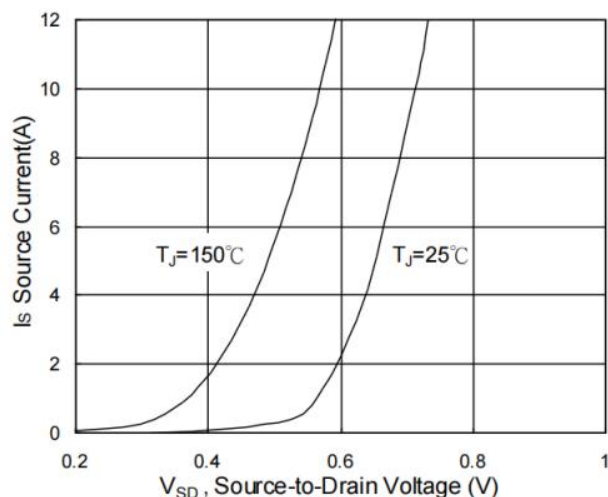
- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=28A$
- 4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature 5.The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation



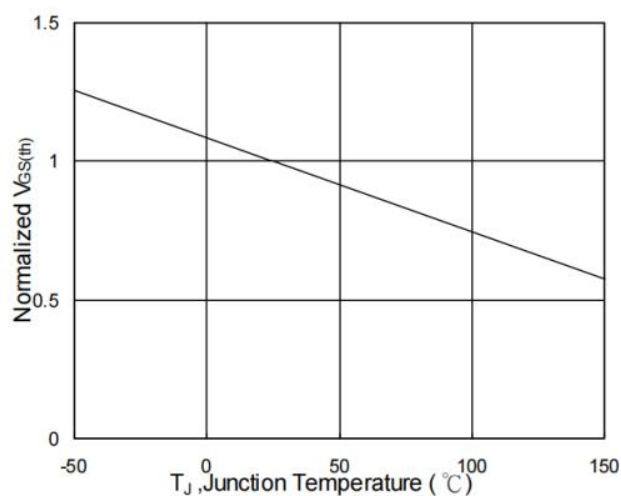
### Typical Characteristics



**Fig.1 Typical Output Characteristics**

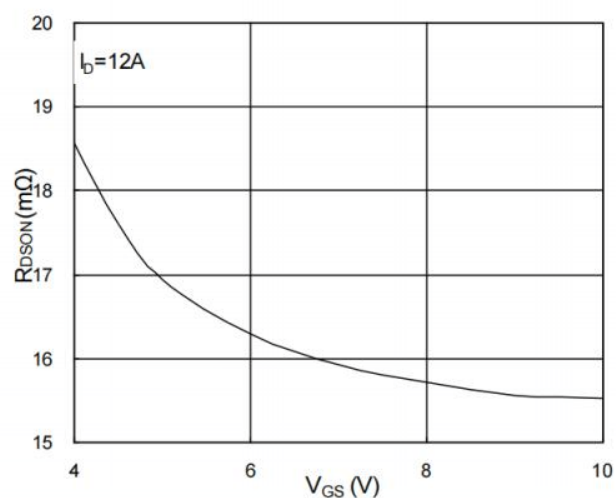


**Fig.3 Forward Characteristics of Reverse**

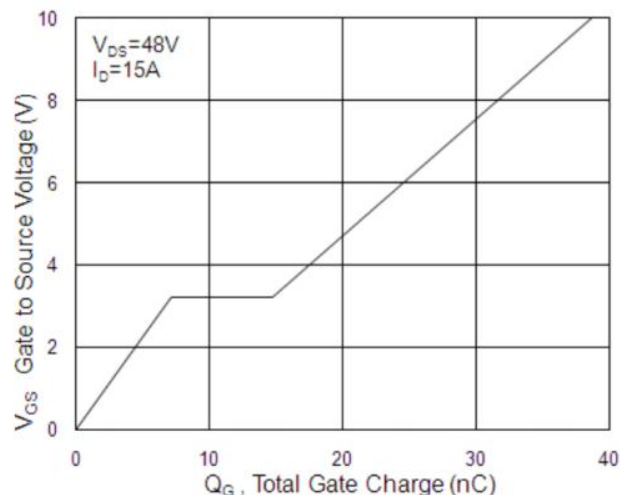


**Fig.5 Normalized  $V_{GS(th)}$  v.s  $T_J$**

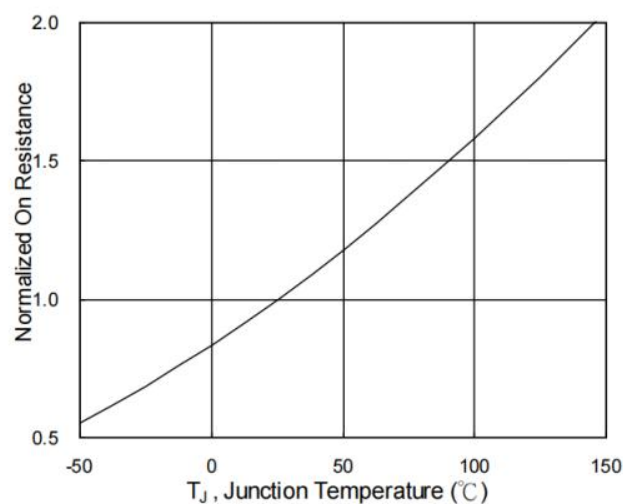
### 60V N-Channel Enhancement Mode MOSFET



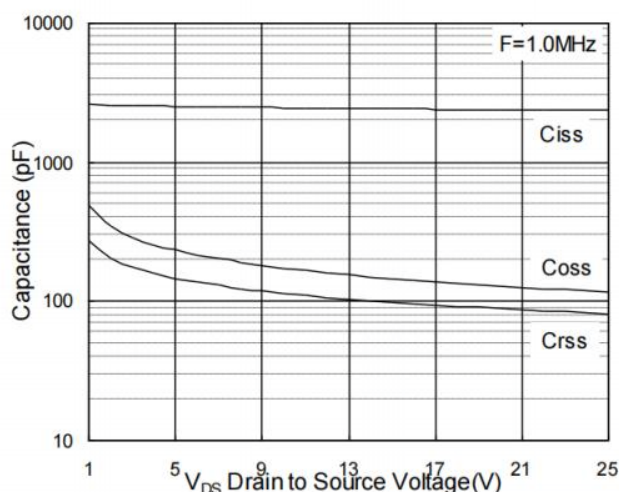
**Fig.2 On-Resistance v.s Gate-Source**



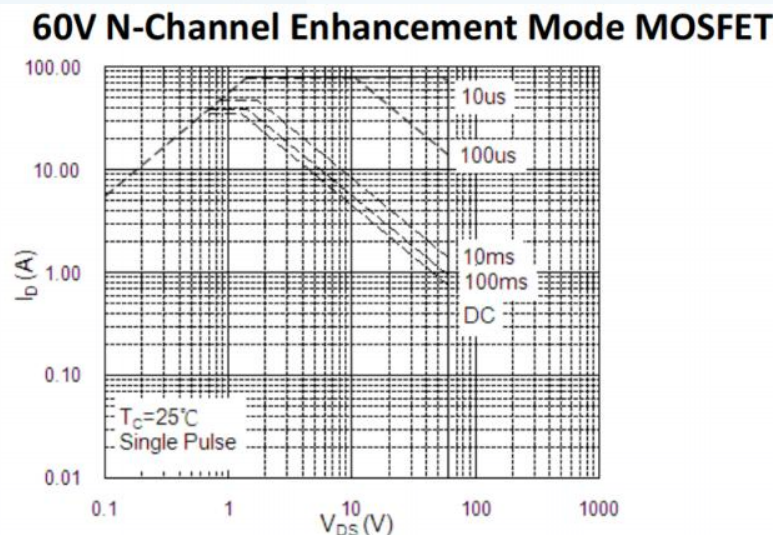
**Fig.4 Gate-Charge Characteristics**



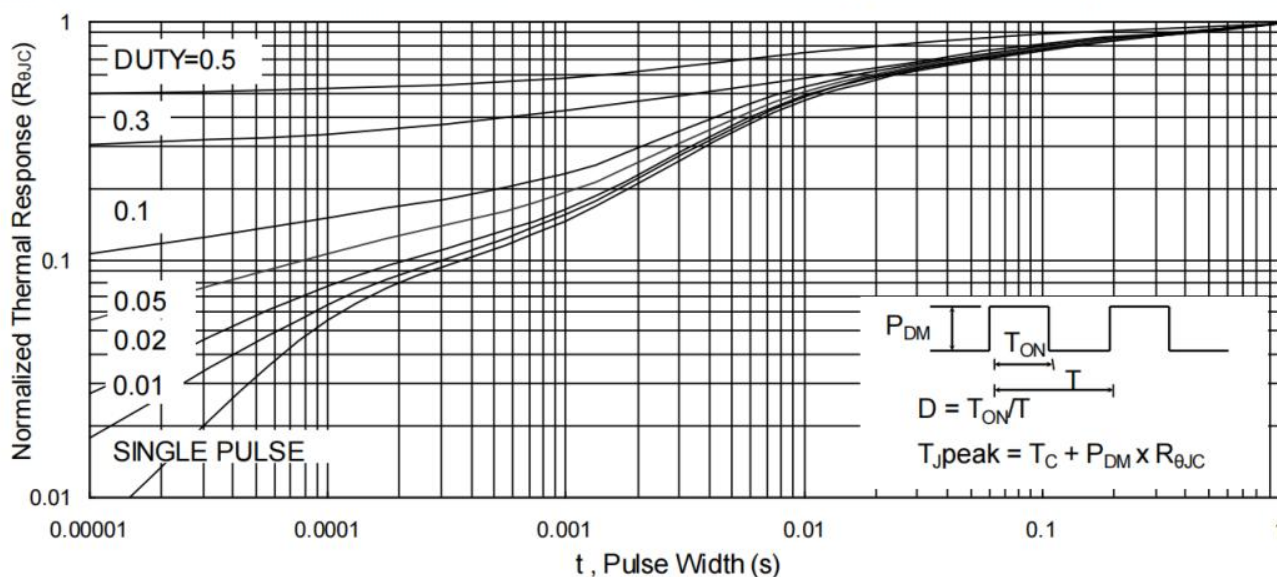
**Fig.6 Normalized  $R_{DS(on)}$  v.s  $T_J$**



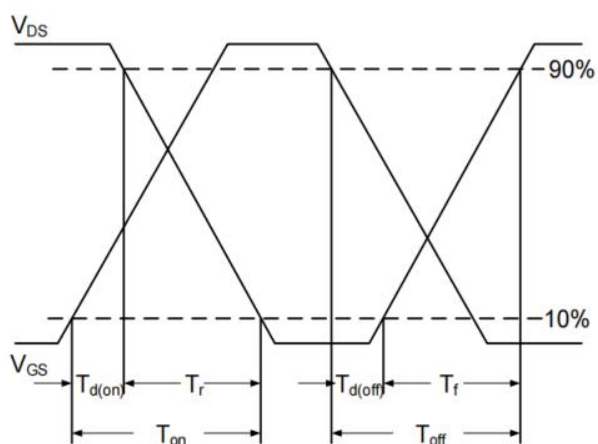
**Fig.7 Capacitance**



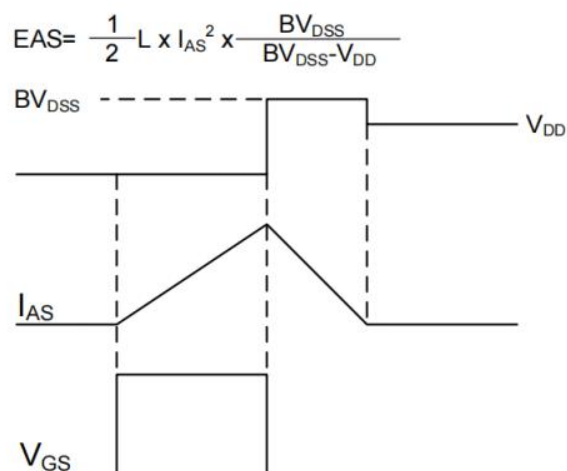
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**



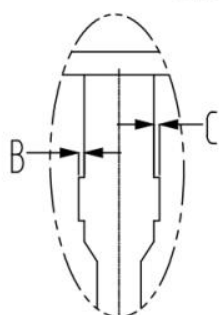
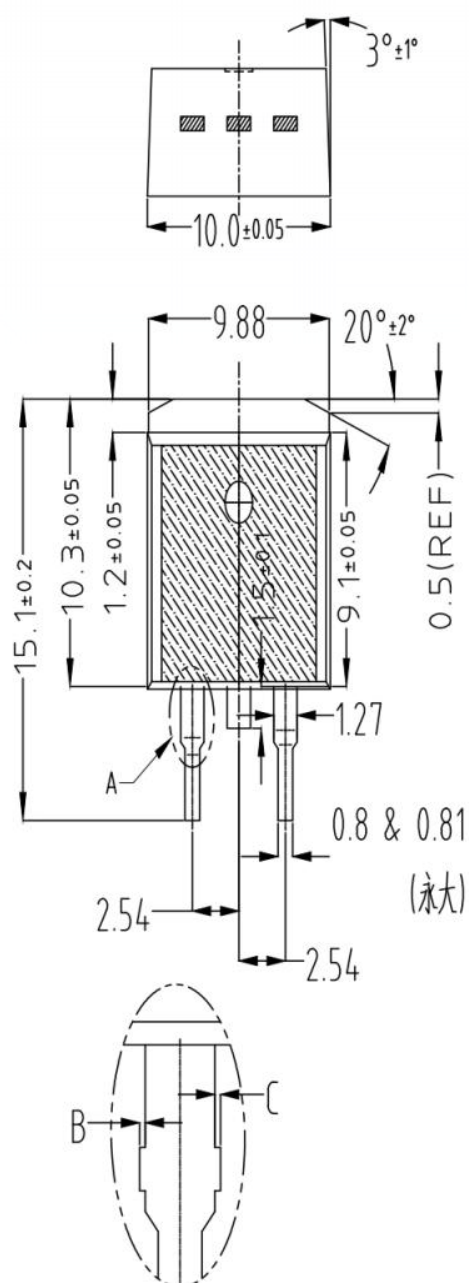
**Fig.10 Switching Time Waveform**



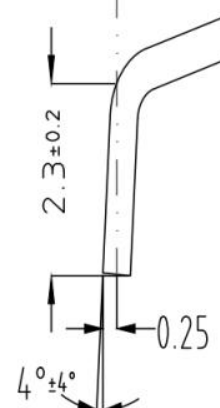
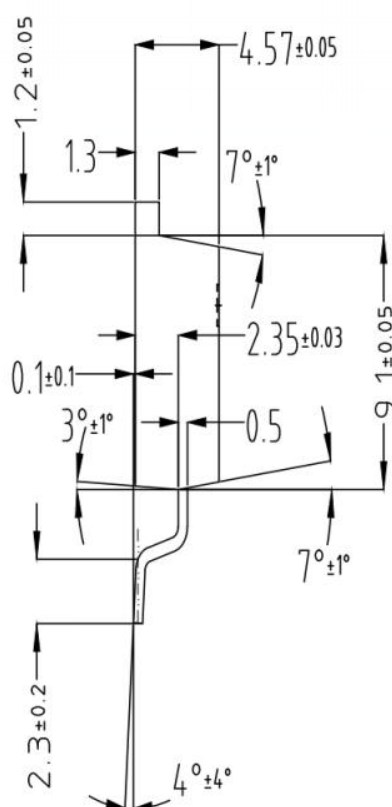
**Fig.11 Unclamped Inductive Switching Waveform**

**60V N-Channel Enhancement Mode MOSFET**
**TO-263 Package Outline Dimensions**

Package Outline Dimensions (Units: mm)



$$0 < B, C < 0.076$$





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